REVISION : A1

PAGE : 1 OF 9

# 1/3W, 1206, Low Resistance Chip Resistor (Lead free / Halogen Free)

# 1. Scope

This specification applies to 3.2mm x 1.6mm size 1/3W, fixed thick film low resistance value chip resistors rectangular type.

# 2. Type Designation

RLT1632 - F - 
$$\square$$
  $\square$   $\square$   $\square$   $\square$   $\square$   $\square$   $\square$ 

Where

- (1) Size No.
- (2) Power Rating:

$$F = 1/3W$$

(3) Resistance value: Refer to paragraph 4-1

For example --

Four digits of number

$$R100 = 0.1\Omega$$

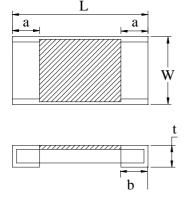
$$1R00 = 1.0\Omega$$

The "R" shall be used as a decimal point

(4) Resistance tolerance:

$$F = \pm 1.0\%$$
,  $G = \pm 2\%$ ,  $J = \pm 5\%$ 

### 3. Outline Dimensions



Code Letter	Dimension
L	$3.20 \pm 0.20$
W	$1.60 \pm 0.20$
t	$0.60 \pm 0.10$
a	$0.50 \pm 0.25$
b	$0.50 \pm 0.25$

Unit: mm

REVISION : A1

PAGE : 2 OF 9

## 4. Ratings

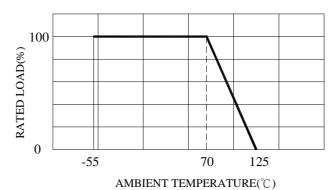
# 4-1 Specification

### Table 1

Power Rating*	1/3 W	
Resistance Tolerance	1%(F), 2%(G), 5%(J)	
Resistance Range	$0.05\Omega \sim <0.1\Omega$	0.1Ω ~ <10Ω
Temperature Coefficient of Resistance(ppm/°C)	0 ~ +250	0 ~ +200

Note\*:

Power Rating is based on continuous full load operation at rated ambient temperature of  $70^{\circ}$ C. For resistor operated at ambient temperature in excess of  $70^{\circ}$ C, the maximum load shall be derated in accordance with the following curve.



# 4-2 Rated Voltage

The d.c. or a.c. r.m.s. voltage shall be calculated from the following expression

$$V = \sqrt{P \times R}$$

Where V : Rated voltage (V)

P : Rated power (W)

R : Nominal resistance  $(\Omega)$ 

# 4-3 Operating and Storage Temperature Range

REVISION : A1

PAGE : 3 OF 9

# 5. Marking

Each Resistor is marked with 4 digits code on the protective coating to designate to the nominal resistance value.

$$0.05 \leq R < 10\Omega$$
 , Marking 4 digits

EX) 
$$0.05\Omega \rightarrow \boxed{R050}$$
 ,  $0.1\Omega \rightarrow \boxed{R100}$   
 $4.7\Omega \rightarrow \boxed{4R70}$  ,  $10\Omega \rightarrow \boxed{10R0}$ 

### 6. Characteristics

### 6-1 Electrical

Item	Specification and Requirement	Test Method (JIS 5201)
Temperature Coefficient	As follow table 1.	Room temperature
of Resistance(ppm/°C)		Room temperature +100°C
Short Time Overload	△ R:±1.0%	(1) Applied voltage: 2.5 x rated
	Without damage by flashover, spark,	voltage
	arcing, burning or breakdown	(2) Test time: 5 seconds
Insulation Resistance	Over $100  \mathrm{M}\Omega$ on Overcoat layer	(1) Setup as figure 1
	face up	(2) Test voltage: 100V <sub>DC</sub> ±15V <sub>DC</sub>
	Over 1,000 M $\Omega$ on Substrate side	(3) Test time: $60 + 10 / - 0$ seconds
	face up	
Voltage Proof	Resistance range:±1.0%	(1) Setup as figure 1
	Without damage by flashover, spark,	(2) Test voltage: 400V <sub>AC</sub> (rms.)
	arcing, burning or breakdown	(3) Test time: $60 + 10 / - 0$ seconds

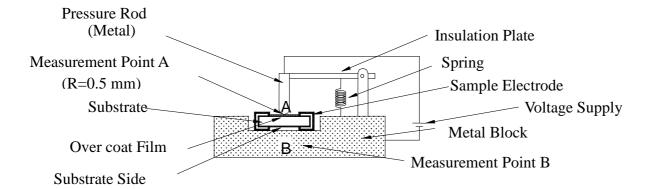


Figure 1: Measurment Setup



REVISION : A1

PAGE : 4 OF 9

Item	Specification and Requirement	Test Method (JIS 5201)
Solderability	The surface of terminal immersed shall be minimum of 95% covered with a new coating of solder	Solder bath: After immersing in flux, dip in $245 \pm 5^{\circ}$ C molten solder bath for $2 \pm 0.5$ seconds
Resistance to Solder Heat	$\triangle$ R: $\pm$ 1.0% Without distinct deformation in appearance	<ul> <li>(1) Pre-heat: 100~110°C for 30 seconds</li> <li>(2) Immersed at solder bath of 270 ± 5°C for 10 ± 1 seconds</li> <li>(3) Measuring resistance 1 hour after test</li> </ul>
Bending Test	$\triangle$ R: $\pm$ 1.0% Bending value: 3 mm for 30 $\pm$ 1 Without mechanical damage such as break	
Solvent Resistance	Without mechanical and distinct damage in appearance	<ul><li>(1) Solvent: Trichloroethane or Isopropyl alcohol</li><li>(2) Immersed in solvent at room temperature for 300 seconds</li></ul>



REVISION : A1

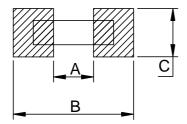
PAGE : 5 OF 9

# SPECIFICATION FOR APPROVAL

Item	Specification and Requirement	Test Method (JIS 5201)
Rapid Change of Temperature	△ R:±1.0% Without distinct damage in appearance	(1) Repeat 5 cycle as follow:  (-55 ± 3°C,30minutes)  →(Room temperature, 2~3 minutes)  →(+125 ± 2°C,30minutes)  →(Room temperature 2~3 minutes)  (2) Measuring resistance  1 hour after test
Moisture with Load	∴ R: ±5.0%  Without distinct damage in appearance	<ul> <li>(1) Environment condition: 40 ± 2°C,90~95% RH</li> <li>(2) Applied Voltage: rated voltage</li> <li>(3) Test period: (1.5 hour ON) →(0.5 hour OFF) cycled for total 1,000 + 48 / - 0 hours</li> <li>(4) Measuring resistance 1 hour after test</li> </ul>
Load Life	△ R: ±5.0% Without distinct damage in appearance	<ul> <li>(1) Test temperature: 70 ± 3°C</li> <li>(2) Applied Voltage: rated voltage</li> <li>(3) Test period: (1.5 hour ON)</li> <li>→(0.5 hour OFF) cycled for total</li> <li>1,000 + 48 / - 0 hours</li> <li>(4) Measuring resistance</li> <li>1 hour after test</li> </ul>
Low Temperature Store	△ R: ± 5.0% Without distinct damage in appearance	<ul> <li>(1) Store temperature: -55 ± 3°C for total 1,000 + 48 / - 0 hours</li> <li>(2) Measuring resistance 1 hour after test</li> </ul>
High Temperature Store	<ul><li>∴ R: ± 5.0%</li><li>Without distinct damage in appearance</li></ul>	<ul> <li>(1) Store temperature: +125 ± 2°C for total 1,000 + 48 / - 0 hours</li> <li>(2) Measuring resistance 1 hour after test</li> </ul>

REVISION : A1

PAGE : 6 OF 9

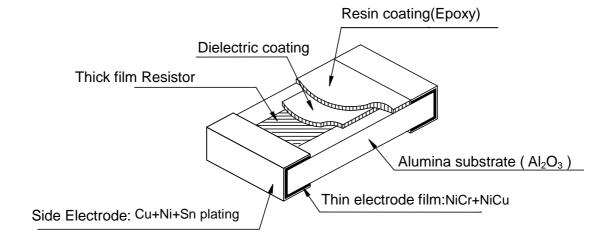


**Recommend Land Pattern Dimensions** 

A	2.2~2.6
В	4.4~4.8
C	1.8~2.4

Unit: mm

# 8. Construction Drawing



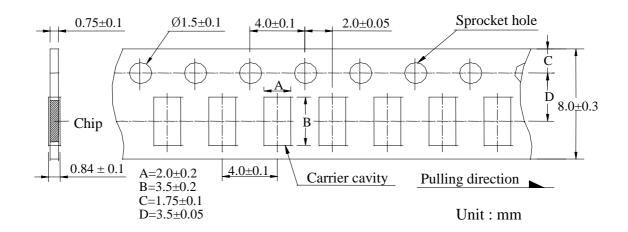
REVISION : A1

PAGE : 7 OF 9

# 9. Packaging

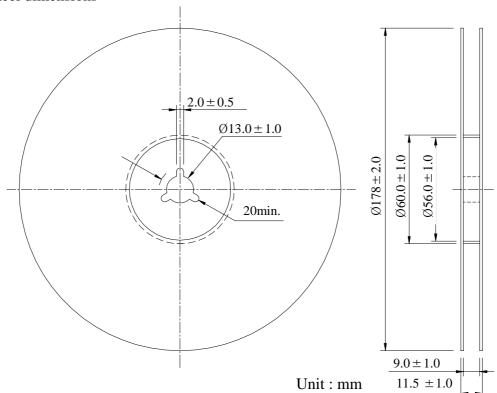
# 9-1 Dimensions

# 9-1-1 Tape packaging dimensions



Remark: Leader tape length ≥ 30 cm( 150 Hollow carrier cavity)

### 9-1-2 Reel dimensions



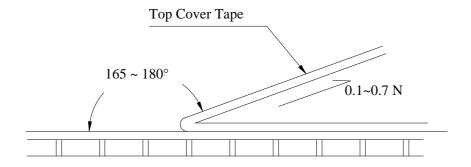
REVISION : A1

PAGE : 8 OF 9

# 9-2 Peel force of top cover tape

The peel speed shall be about 300 mm/min.

The peel force of top cover tape shall be between 0.1 to 0.7 N.



# 9-3 Numbers of taping 5,000 pieces /reel

# 9-4 Label making

The following items shall be marked on the reel.

- (1) Type designation.
- (2) Quantity
- (3) Manufacturing date code
- (4) Manufacturer's name

REVISION : A1

PAGE : 9 OF 9

### 10. Carenote

### 10-1 Care note for storage

- (1) Chip resistor shall be stored in a room where temperature and humidity must be controlled. (temperature 5 to 35°C, humidity 45 to 85% RH) However, a humidity keep it low, as it is possible.
- (2) Chip resistor shall be stored as direct sunshine doesn't hit on it.
- (3) Chip resistor shall be stored with no moisture, dust, a material that will make solderability inferior, and a harmful gas (Chloridation hydrogen, sulfurous acid gas, and sulfuration hydrogen)

### 10-2 Carenote for operating and handling

- (1) It is necessary to protect the edge and protection coat of resistors from mechanical stress.
- (2) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
- (3) Resistors shall be used with in rated range shown in specification. Especially, if voltage more than specified value will be loaded to resistor, there is a case it will make damage for machine because of temperature rise depending on generating of heat, and increase resistance value or breaks.
- (4) In case that resistor is loaded a rated voltage, it is necessary to confirms temperature of a resistor and to reduce a load power according to load reduction curve, because a temperature rise of a resistor depends on influence of heat from mounting density and neighboring element.
- (5) Observe Limiting element voltage and maximum overload voltage specified in each specification
- (6) If there is possibility that a large voltage (pulse voltage, shock voltage) charge to resistor, it is necessary that operating condition shall be set up before use.